MPM (Divider)

Vishay Thin Film



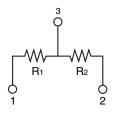
Molded, SOT-23 Resistor Network





Vishay Thin Film MPM Series Dividers provide \pm 2 ppm/°C tracking and a ratio tolerance as tight as 0.01 %, small size, and exceptional stability for all surface mount applications. The standard SOT-23 package format with unity and common standard resistance divider ratios provide easy selection for most applications requiring matched pair resistor elements. The ratios listed are available for off the shelf delivery. If you require a non-standard ratio, consult the applications engineering group as we may be able to meet your requirements with a custom design.

SCHEMATIC



FEATURES

- Lead (Pb)-free available
- Stocked
- Standard Footprint



RoHS*

TYPICAL PERFORMANCE

	ABS	TRACKING	
TCR	25	2	
	ABS	RATIO	
TOL	0.1	0.05	

STANDARD DIVIDER RATIO (R ₂ /R ₁)					
RATIO	$R_2(\Omega)$	R ₁ (Ω)			
100:1	100K	1K			
50:1	50K	1K			
25:1	25K	1K			
20:1	20K	1K			
10:1	10K	1K			
9:1	9K	1K			
6:1	6K	1K			
5:1	10K	2K			
5:1	5K	1K			
4:1	8K	2K			
4:1	4K	1K			
2:1	10K	5K			
2:1	2K	1K			
1:1	50K	50K			
1:1	25K	25K			
1:1	10K	10K			
1:1	5K	5K			
1:1	2.5K	2.5K			
1:1	1K	1K			
1:1	500	500			
1:1	250	250			

STANDARD ELECTRICAL SPECIFICATIONS					
TEST Material		SPECIFICATIONS	CONDITIONS		
		Passivated Nichrome			
TCR:	Tracking	± 2 ppm/°C (typical)	- 55 °C to + 125 °C		
	Absolute	± 25 ppm/°C	- 55 °C to + 125 °C		
Tolerance:	Ratio	± 0.5 % to 0.01 %	+ 25 °C		
	Absolute	± 1.0 % to ± 0.05 %	+ 25 °C		
Power Rating:	Resistor	100 mW	Max. at + 70 °C		
Power Haung:	Package	200 mW	Max. at + 70 °C		
Stability:	∆R Absolute	0.10 %	2000 h at + 70 °C		
	∆ <i>R</i> Ratio	0.03 %	2000 h at + 70 °C		
Voltage Coefficient		0.1 ppm/V			
Working Voltage	100 Volts Max.	-			
Operating Temperature Range		- 55 °C to + 125 °C			
Storage Temperature Range		- 55 °C to + 125 °C			
Noise		< - 30 dB			
Thermal EMF		0.2 μV/°C			
Shelf Life Stability (Ratio)		50 ppm Max.	1 year at + 25 °C		

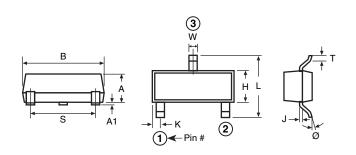
^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



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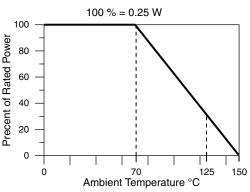
DIMENSIONS AND IMPRINTING in inches and millimeters

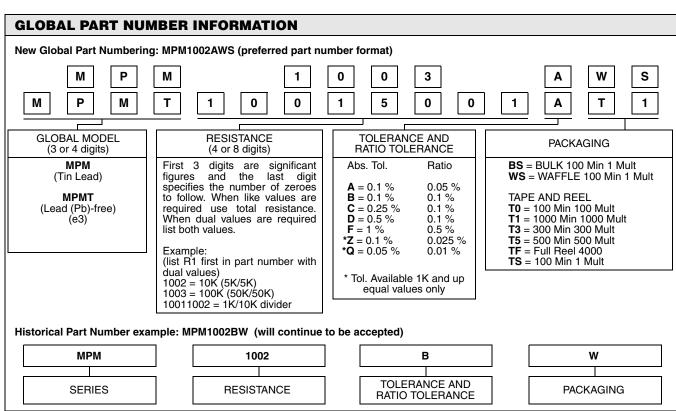


DIMENSION	INCHES		ММ	
	MIN.	MAX.	MIN.	MAX.
Α	0.031	0.040	0.79	1.02
A1	0.001	0.004	0.02	0.10
В	0.105	0.120	2.67	3.05
S	0.071	0.079	1.80	2.00
W	0.015	0.021	0.38	0.54
L	0.083	0.098	2.10	2.50
Н	0.047	0.055	1.20	1.40
Т	0.005	0.010	0.13	0.25
J	0.0035	0.0059	0.089	0.15
K	0.017	0.022	0.44	0.55
Ø	0	8°	0	8°

MECHANICAL SPECIFICATIONS Resistive Element Passivated Nichrome Substrate Material Silicon Body Molded epoxy Terminals Copper alloy #42 Sn62 plated Lead Coplanarity 3 Mils Max. Lead (Pb)-free Option 100 % Sn Matte Lead (Pb)-free Finish Plated

DERATING CURVE







Vishay

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